SIEMENS

Data sheet

6AG1195-7HC00-2XA0

SIPLUS ET200M ACTIVE BUS MODULE FOR INTEGRATION OF AN 80 MM WIDE I/O MODULE -40 ... +70 DGR C WITH CONFORMAL COATING BASED ON 6ES7195-7HC00-0XA0 . FOR FUNCTION: INSERT AND REMOVE



Figure similar

Standards, approvals, certificates		
CE mark	Yes	
UL approval	Yes; File E239877	
FM approval	Yes; CofC 3028431	
RCM (formerly C-TICK)	Yes	
KC approval	Yes	
EAC (formerly Gost-R)	Yes	

Ambient conditions		
Ambient temperature during operation		
• min.	-40 °C; = Tmin	
• max.	70 °C; = Tmax; 60 °C @ UL/cUL, ATEX and FM use	
Ambient temperature during storage/transportation		
• min.	-40 °C	
• max.	70 °C	
Extended ambient conditions		

• relative to ambient temperature-atmospheric pressure-installation altitude

Tmin ... Tmax at 1080 hPa ... 795 hPa (-1000 m ... +2000 m) //
Tmin ... (Tmax - 10K) at 795 hPa ... 658 hPa (+2000 m ... +3500 m) // Tmin ... (Tmax - 20K) at 658 hPa ... 540 hPa (+3500 m ... +5000 m)

Relative humidity

— With condensation, tested in accordance with IEC 60068-2-38, max.

100 %; RH incl. condensation/frost (no commissioning under condensation conditions)

Resistance

 against biologically active substances / conformity with EN 60721-3-3 Yes; Class 3B2 mold, fungus and dry rot spores (with the exception of fauna). The supplied connector covers must remain on the unused interfaces during operation!

 against chemically active substances / conformity with EN 60721-3-3 Yes; Class 3C4 (RH < 75%) incl. salt spray according to EN 60068-2-52 (degree of severity 3). The supplied connector covers must remain on the unused interfaces during operation!

 against mechanically active substances / conformity with EN 60721-3-3 Yes; Class 3S4 incl. sand, dust. The supplied connector covers must remain on the unused interfaces during operation!

Accessories

belongs to product ET 200M

Dimensions

Width	97 mm
Height	92 mm
Depth	30 mm

Weights

Weight, approx. 127 g

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